Package

SMini3-F1

1: Cathode 1

2: Cathode 2 3: Anode

Marking Symbol: M3E

Internal Connection

Pin Name

Code

MA3J745D (MA745WA)

Silicon epitaxial planar type

For switching

Features

- Two elements are contained in one package, allowing highdensity mounting
- Low forward voltage V_F , optimum for low voltage rectification
- Optimum for high frequency rectification because of its short reverse recovery time t_{rr}

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter			Unit	
Reverse voltage			v	
Maximum peak reverse voltage			V	
Single	T	30	mA	
Double	IF	20		
Single	I _{FM}	150	mA	
Double		110		
	Tj	125	°C	
	T _{stg}	-55 to +125	°C	
	Single Double Single	Single IF Double IF Single IFM Double Tj	$\begin{tabular}{ c c c c c c } \hline V_R & V_R & 30 \\ \hline V_{RM} & 30 \\ \hline Single & & & & & & \\ \hline Double & I_F & & & & & \\ \hline Double & & & & & & & \\ \hline Single & & & & & & & & \\ \hline Double & & & & & & & & \\ \hline Double & & & & & & & & & \\ \hline T_j & & & & & & & & & \\ \hline \end{array} $	

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

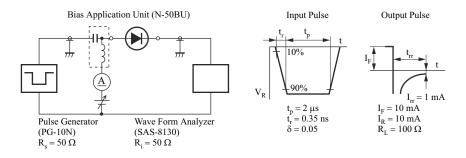
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _{F1}	I _F = 1 mA	1,1,0		0.3	V
	V _{F2}	$I_F = 30 \text{ mA}$	50 55	27	1.0	
Reverse current	IR	$V_R = 30 V$	Ro		30	μΑ
Terminal capacitance	Ct	$V_R = 1 V, f = 1 MHz$,2	1.5		pF
Reverse recovery time *	t _{rr}	$I_F = I_R = 100 \text{ mA}, I_{rr} = 10 \text{ mA},$ $R_L = 100 \Omega$		1.0		ns
Detection efficiency	η	$V_{IN} = 3 V_{(peak)}$, f = 30 MHz R _L = 3.9 kΩ, C _L = 10 pF		65		%

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

3. Absolute frequency of input and output is 2 GHz

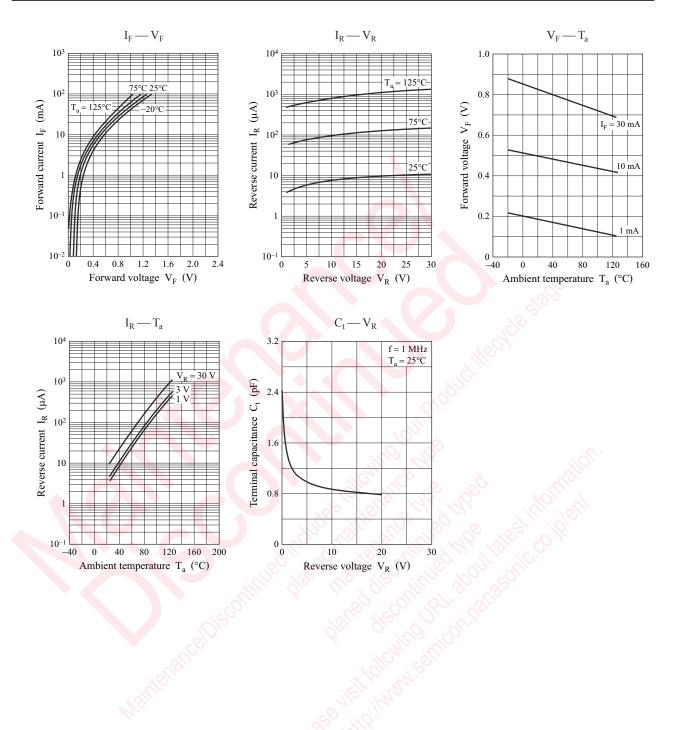
4. *: t_{rr} measurement circuit



Note) The part number in the parenthesis shows conventional part number.

MA3J745D

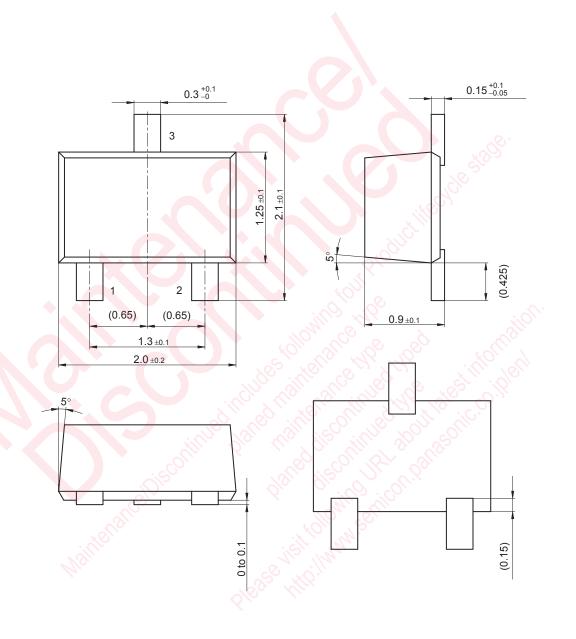
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SMini3-F1

Unit: mm



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